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FORM P10-1595 (Modified) (Rev. 03-01) OMB No. 0651-0027 (exp.5/31/2002) P08A/REV03 08-03-2006



Docket No.: 21C-0354

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U.S. DEPARTMENT OF COMMERCE

Patent and Trademark Office

Tab settings → → → ▼ 10328		_		
To the Director of the United States Patent and Trademark Off	ice: Please record the attached original documents or copy thereof.			
1. Name of conveying party(ies): Shin-Tack KANG, Dong-Hyeon KI, Sung-Man KIM, Sang-Hoon LEE	Name and address of receiving party(ies): Name: SAMSUNG ELECTRONICS CO., LTD			
	Address: 416, Maetan-dong, Yeongtong-gu			
Additional names(s) of conveying party(ies)	0.64 0.00 0.00 0.00 0.00 0.00 0.00 0.00			
3. Nature of conveyance:				
☐ Security Agreement ☐ Change of Name	City: Suwon-si State/Prov.: Gyeonggi-do	-		
☐ Other	Country: Korea ZIP:	-		
Execution Date: June 27, 2006	Additional name(s) & address(es) ☐ Yes ☒ No			
4. Application number(s) or patent numbers(s):				
If this document is being filed together with a new application,	the execution date of the application is: June 27, 2006	_		
Patent Application No. Filing date	B. Patent No.(s)			
Tatent Application No.				
Additional numbers	☐ Yes ☒ No			
	6. Total number of applications and patents involved:	7		
5. Name and address of party to whom correspondence concerning document should be mailed:	o. Total number of applications and paterns involved.	┛		
Name: Amy Bizon-Copp	7. Total fee (37 CFR 3.41):\$ 40.00			
Registration No. 53,993	☐ Enclosed - Any excess or insufficiency should be			
Address: Cantor Colburn LLP	credited or debited to deposit account			
	☑ Authorized to be charged to deposit a count			
55 Griffin Road South	8. Deposit account number:	\exists		
	o. Deposit account number.			
City: Bloomfield State/Prov.: CT	06-1130			
Country: USA ZIP: 06002	(Attach duplicate copy of this page if paying by descipate count)			
	T USE THIS SPACE			
9. Statement and signature. To the best of my knowledge and belief, the foregoing information is true and correct and any attached company is a true copy of the original document.				
Amy Bizon-Copp AMY	Byn-lopp July 27 2006			
Name of Person Signing Total number of pages including co	Signature / 3 3 attention over sheet, attachments, and document:			

ASSIGNMENT

WHEREAS We, Shin-Tack KANG of 230-1801 Seongwon Santevill, Sanghyeon-dong, Yongin-si, Gyeonggi-do, Korea, Dong-Hyeon KI of 410-1105 Jugong 9danji APT., Ssangyong3-dong, Cheonan-si, Chungcheongnam-do, Korea, Sung-Man KIM of 30-508 Jangmi APT., Shincheon-dong, Songpa-gu, Seoul, Korea and Sang-Hoon LEE of 27-605 Hanyang APT., Songpa2-dong, Songpa-gu, Seoul, Korea (hereinafter referred to as "ASSIGNORS"); have invented certain new and useful improvements in:

DISPLAY SUBSTRATE, METHOD OF MANUFACTURING THE SAME AND DISPLAY DEVICE HAVING THE SAME

which claims priority to Korean Application No. <u>2005-71591</u>, filed on <u>August 5, 2005</u> and for which We are about to file an application for Letters Patent of the United States;

AND WHEREAS, SAMSUNG ELECTRONICS CO., LTD (hereinafter referred to as "ASSIGNEE"), a corporation organized and existing under the laws of the Country of Korea, having a place of business at 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, Korea is desirous of acquiring an interest in the United States and all foreign countries, in and to the said invention and Letters Patent to be obtained therefor;

NOW THEREFORE, TO ALL WHOM IT MAY CONCERN, be it known that, for good and valuable consideration, the receipt of which is hereby acknowledged, We, the said ASSIGNORS have assigned and transferred, and hereby assign and transfer unto the said ASSIGNEE, the entire right, title and interest in and to said invention in the United States and in all foreign countries, including priority rights, as fully set forth and described in said application; and We do hereby authorize and request the Commissioner of Patents to issue said Letters Patent on said application, and any and all Letters Patent that may be issued upon any and all revivals, refilings, continuations, continuations-in-part, divisions and reissues thereof, to the said ASSIGNEE, an assignee of the entire right, title and interest in and to the same, for the sole use and behoof of ASSIGNEE, its successors and assigns; and We do hereby agree that the said ASSIGNEE, may apply for foreign Letters Patent on said invention and that We will execute all papers necessary in connection with the United States and foreign applications when called upon to do so by the said ASSIGNEE, its successors or assigns, and that We will,

PATENT REEL: 018140 FRAME: 0164 at the cost and expense of the said ASSIGNEE fully assist and cooperate in all matters in connection with the United States and foreign applications and patents issuing thereon.

The undersigned declare that all statements made herein of their own knowledge are true and that all statements made on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

Date:	2006-6-27	Shim Tack Kang Shin-Tack KANG	L.S
Date:	2006 - 6 - 27	Dong - Hyeon KI Dong-Hyeon KI	L.S
Date:	2006-6.27	Kim Sung Man Sung-Man KIM	L.S
Date:	2006 6-27	Sang Hoon Lee Sang-Hoon LEE	L.S

PATENT REEL: 018140 FRAME: 0165

RECORDED: 07/27/2006